# **Gain Equalizer - RC Network**





#### **GENERAL DESCRIPTION**

**APPLICATIONS** 

TOSA / ROSA

**Broadband Receiver** 

· Optical Transceiver Modules

These ruggedly constructed, ultraminiature (EIA 0402, 1005 metric) equalizers combine high-performance tantalum nitride resistive elements and silicon/oxygen/nitrogen capacitive elements with KYOCERA AVX's proprietary, glass-sandwich FLEXITERM® surface-mount technology, which provides an extra measure of protection against flexure damage during installation. The new GEQ Series equalizers are also manufactured with 100% laser trimming to achieve tight tolerances and offer a low 0.5mm profile, a 125mW power rating, resistance values spanning 10–50 $\Omega$ , and capacitance values extending from 1–50pF.

Rated for a wide range of operating temperatures (-55°C to +125°C) and compliant with RoHS, ideal applications for the series extend across the optoelectronic, telecommunications, broadband, military, electronic warfare, space, test, and instrumentation markets and include optical transceiver modules, broadband receivers, and transmission and receiver optical subassemblies (TOSA and ROSA).

MARKETS

Telecom

Military

Opto-electronics

Broadband Jamming for EW

Instrumentation and Test

#### **FEATURES**

- EIA 0402 Case Size
- Resistance Range: 10 to 50  $\Omega$  typ.
- Capacitance Range: 1 to 50 pF typ.
- Parallel Configurations
- Power Rating: 125 mW
- Operating Temperature: -55°C to +125°C
- Laser Trimmed Resistors
- RoHS Compliant

\*For other RC Combinations and EIA Sizes contact factory



#### CLICK HERE TO DOWNLOAD DATA FILES

#### **HOW TO ORDER**



#### **EQUALIZER GAIN SLOPE TABLE**

Part Number	Starting Frequency (Typical) (GHz)	Loss at Starting Frequency (Typical) (dB)	End Frequency (Typical) (GHz)	Loss at End Frequency (Typical) (dB)	Bandwidth (Typical) (GHz)	Gain (Typical) (dB)
RCN25R0F00R5MTTR	5	-1.5	16	-0.2	11	1.3
RCN25R0F01R0MTTR	0	-1.8	12	-0.15	12	1.65
RCN25R0F02R0MTTR	0	-1.8	10	-0.15	10	1.65
RCN25R0F03R0MTTR	0	-1.8	7	-0.15	7	1.65
RCN25R0F04R0MTTR	0	-1.8	6	-0.15	6	1.65
RCN25R0F05R0MTTR	0	-1.8	5	-0.15	5	1.65
RCN25R0F06R0MTTR	0	-1.8	4.5	-0.15	4.5	1.65
RCN25R0F10R0MTTR	0	-1.8	3.5	-0.15	3.5	1.65

# The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at www.kyocera-avx.com/disclaimer/ by reference and should be reviewed in full before placing any order.

# **Gain Equalizer - RC Network**



Tested on Rogers material microstrip board with an Agilent VNA.

The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at www.kyocera-avx.com/disclaimer/ by reference and should be reviewed in full before placing any order.

TDS-STFP-0005 | Rev 1 SPECIALTY THIN FILM PRODUCTS 

# **Gain Equalizer - RC Network**

### **SPECIFICATIONS**

Package Size: EIA 0402Design: Glass wafer sandwichTermination: NiSn platedPower Rating: 125 mWOperating Temperature Range: -55°C to +125°CTolerance: Resistor: 1-5%, Capacitor: 5-20%Resistance Range: 10 to 50 Ω (typical)Capacitance Range: 1 to 50 pF (typical)

#### DIMENSIONS



Size (EIA)	Length (L)	Width (W)	Thickness (T)	Termination (t)
0402	1.02 ± 0.051	0.51 ± 0.051	0.50 ±0.10	0.25 ± 0.051
	(0.040 ± 0.002)	(0.020 ± 0.002)	(.020 ±.004)	(0.010 ± 0.002)

### SUGGESTED MOUNTING PAD DIMENSIONS





**Normal Pads** 

W = Chip Width L = Chip Length T = Chip Thickness

Case Size	A Min.	B Min.	C Min.	D Min.
0402	0.0213	0.0125	0.0206	0.0436
			Dimensions	are in inches

#### NOTES:

Mounting will allow the solder fillet to travel up approximately 0.015" of the chip's end and side termination surface. Heavier fillets require a predeposition of solder paste and or an increase in pad dimensions. Typical solder paste application is a .008" to 0.01" thickness with >50% of volume in solder alloy. Can be mounted in both vertical and horizontal orientation without changing electrical performance

#### **RESISTOR MATERIAL**

Thin Film Resistors	TaN
Typical Sheet Resistivity (ohm/sq)	10 to 100
TCR (ppm/°C, -25 to 125°C)	-100 to -150
Stability (Change after 1000 hours @ 125°C)	1.0%

#### **CAPACITOR MATERIAL**

Material	SiON	
pF/mm Typical	50 to 100	
BDV (v/µm)	600	
DF	≤0.1%	
TCC (ppm/°C, -25 to 125°C)	±60	

### **ENVIRONMENTAL TESTS**

Reliability Test	Criteria		
Life Test	1000 Hrs. @ 125°C @ 50 mW		
85/85 Temp./ Humidity Breakdown	1080 Hrs. @ 50 mW		
Thermal Cycle	100 cycles @ -40 to 125°C		
Termination Strength	200 g for 50 seconds (Dage Tester)x		

The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at www.kyocera-avx.com/disclaimer/ by reference and should be reviewed in full before placing any order.





## **POWER DERATING**



**CALCERTED** The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at www.kyocera-avx.com/disclaimer/ by reference and should be reviewed in full before placing any order.

TDS-STFP-0005 | Rev 1 • SPECIALTY THIN FILM PRODUCTS •